

General Description

The MDS1656 uses advanced MagnaChip's trench MOSFET Technology to provide high performance in on-state resistance, switching performance and reliability

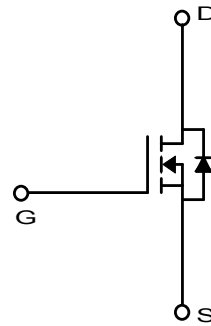
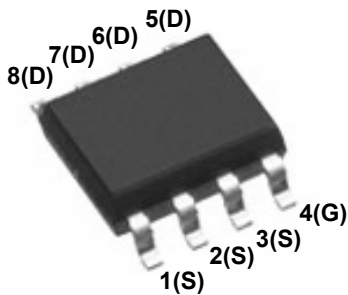
Low $R_{DS(ON)}$, low gate charge can be offering superior benefit in the application.

Features

- $V_{DS} = 30V$
- $I_D = 7.2A$ @ $V_{GS} = 10V$
- $R_{DS(ON)} < 28m\Omega$ @ $V_{GS} = 10V$
- $< 42m\Omega$ @ $V_{GS} = 4.5V$

Applications

- Inverters
- General purpose applications



Absolute Maximum Ratings ($T_a = 25^\circ C$ unless otherwise noted)

Characteristics	Symbol	Rating	Unit
Drain-Source Voltage	V_{DSS}	30	V
Gate-Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current ⁽¹⁾	I_D	$T_C = 25^\circ C$	7.2
		$T_C = 70^\circ C$	6.2
Pulsed Drain Current	I_{DM}	30	A
Power Dissipation	P_D	$T_C = 25^\circ C$	2
		$T_C = 70^\circ C$	1.44
Single Pulse Avalanche Energy ⁽²⁾	E_{AS}	20	mJ
Junction and Storage Temperature Range	T_J, T_{stg}	-55~150	$^\circ C$

Thermal Characteristics

Characteristics	Symbol	Rating	Unit
Thermal Resistance, Junction-to-Ambient(Steady-State) ⁽¹⁾	$R_{\theta JA}$	100	$^\circ C/W$
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	60	

Ordering Information

Part Number	Temp. Range	Package	Packing	RoHS Status
MDS1656R	-55~150°C	SO-8	Tape & Reel	Halogen Free

Electrical Characteristics (T_a = 25°C unless otherwise noted)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D = 250μA, V _{GS} = 0V	30	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.0	1.9	3.0	
Drain Cut-Off Current	I _{DSS}	V _{DS} = 24V, V _{GS} = 0V	-		1	μA
Gate Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V	-	-	0.1	
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 6.9A	-	21.5	28	mΩ
		V _{GS} = 4.5V, I _D = 5.0A	-	31.5	42	
On-State Drain Current	I _{D(ON)}	V _{DS} = 5V, V _{GS} = 4.5V	20	-	-	A
Forward Transconductance	g _{FS}	V _{DS} = 5V, I _D = 6.9A	10	15.4	-	S
Maximum Body-Diode Continuous Current			-	-		
Dynamic Characteristics						
Total Gate Charge	Q _g	V _{DS} = 15V, I _D = 6.9A, V _{GS} = 10V	-	6.94	-	nC
Gate-Source Charge	Q _{gs}		-	1.54	-	
Gate-Drain Charge	Q _{gd}		-	1.4	-	
Input Capacitance	C _{iss}	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz	-	334	-	pF
Reverse Transfer Capacitance	C _{rss}		-	48	-	
Output Capacitance	C _{oss}		-	83	-	
Turn-On Delay Time	t _{d(on)}	V _{GS} = 10V, V _{DS} = 15V, R _L = 2.2Ω, R _{GEN} = 3Ω	-	3.5	-	ns
Turn-On Rise Time	t _r		-	25.4	-	
Turn-Off Delay Time	t _{d(off)}		-	14.2	-	
Turn-Off Fall Time	t _f		-	10.5	-	
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V _{SD}	I _S = 1A, V _{GS} = 0V	-	0.75	1.0	V
Body Diode Reverse Recovery Time	t _{rr}	I _F = 6.9A, di/dt = 100A/μs	-	16.5	20	ns
Body Diode Reverse Recovery Charge	Q _{rr}		-	7.8	10	nC

Notes :

1. Surface mounted RF4 board with 2oz. Copper..
2. Starting T_J = 25°C, L = 1mH, I_{AS} = 5A, V_{DD} = 15V, V_{GS} = 10V.

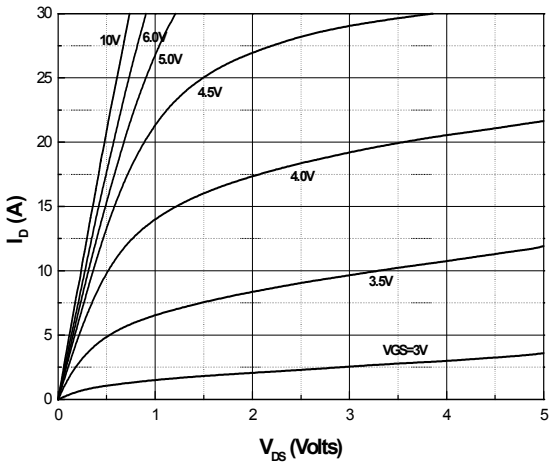


Fig.1 On-Region Characteristics

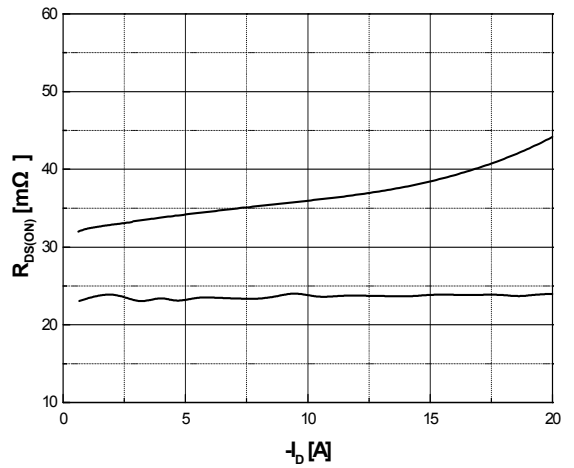


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

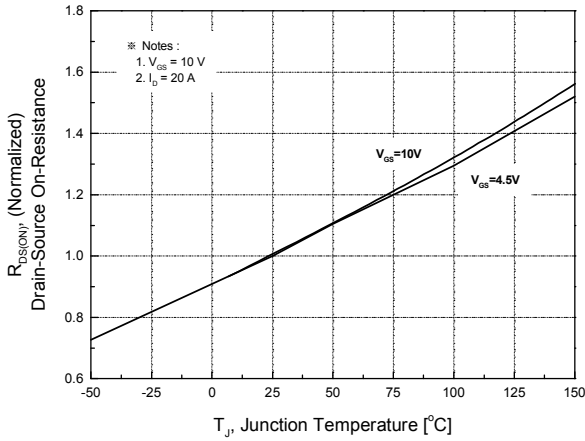


Fig.3 On-Resistance Variation with Temperature

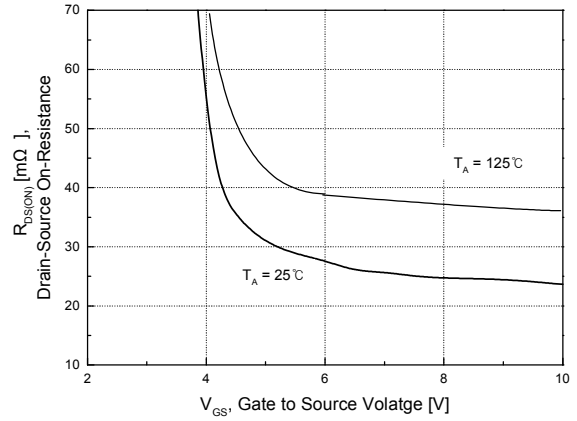


Fig.4 On-Resistance Variation with Gate to Source Voltage

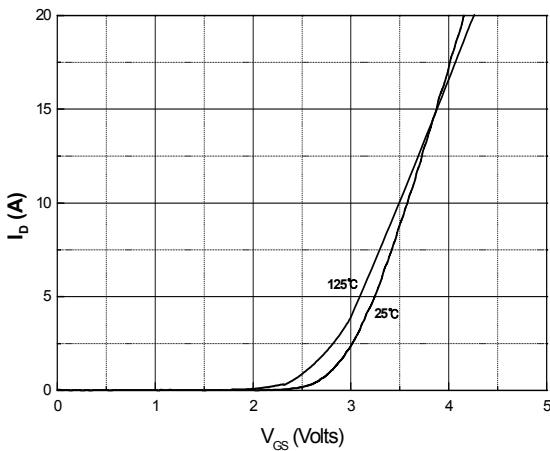


Fig.5 Transfer Characteristics

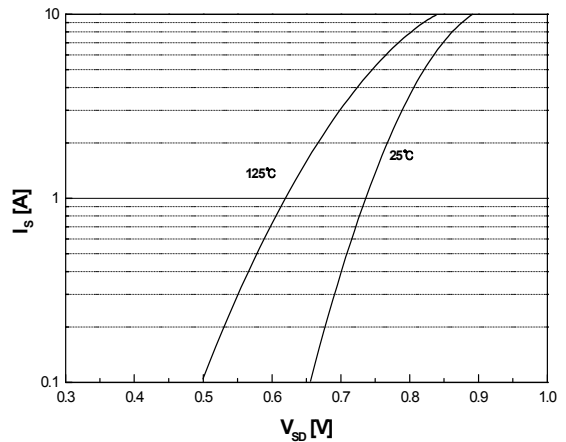


Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature

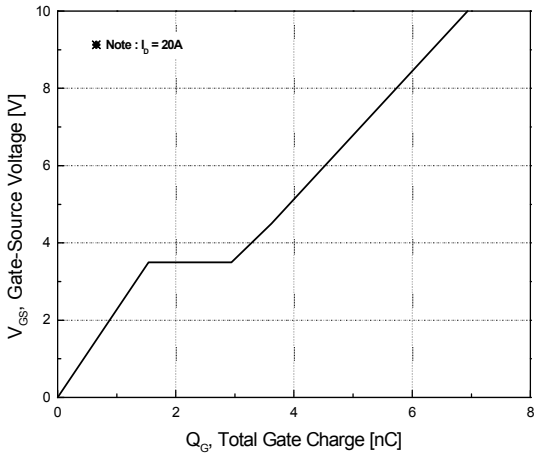


Fig.7 Gate Charge Characteristics

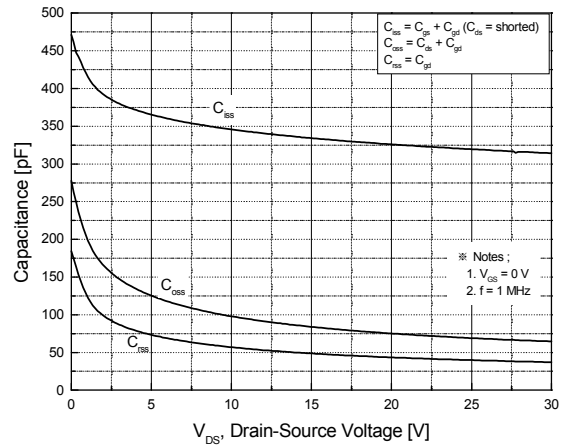


Fig.8 Capacitance Characteristics

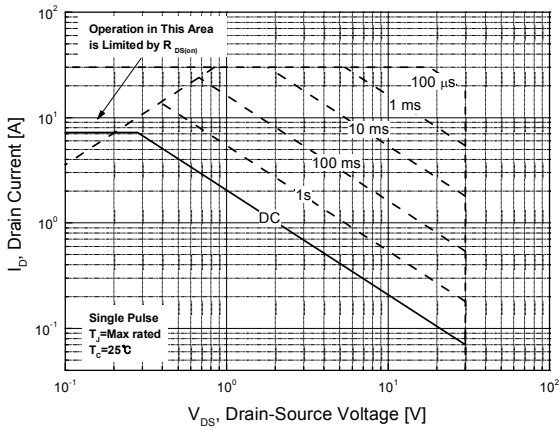


Fig.9 Maximum Safe Operating Area

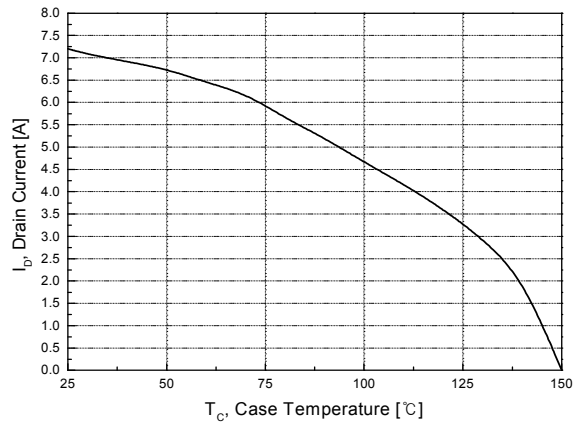


Fig.10 Maximum Drain Current vs. Case Temperature

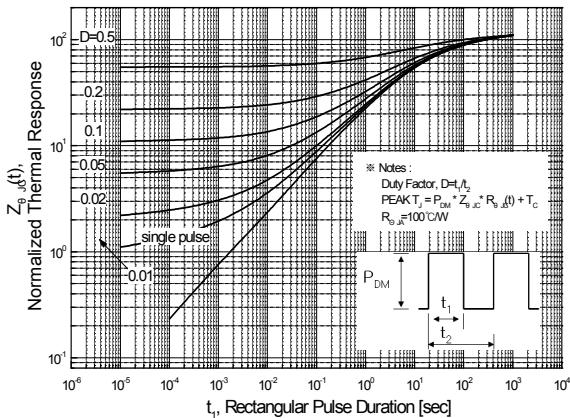
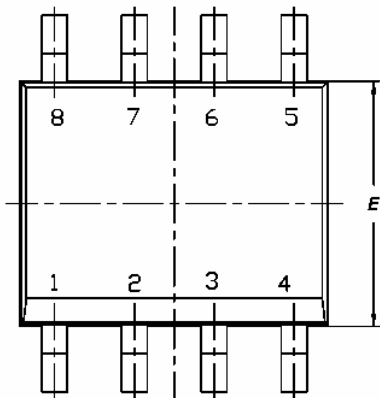


Fig.11 Transient Thermal Response Curve

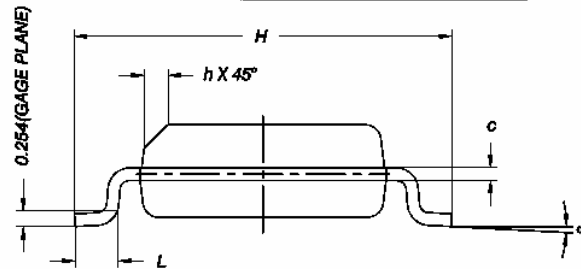
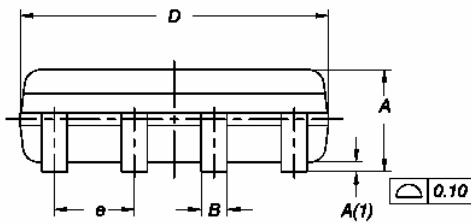
Physical Dimensions

8 Leads SOIC

Dimensions are in millimeters unless otherwise specified



DIM.	MILLIMETERS		
	MIN.	NOM.	MAX.
A	1.35	1.55	1.75
A(1)	0.10	0.175	0.25
B	0.38	0.445	0.51
C	0.19	0.22	0.25
D	4.80	4.90	5.00
E	3.80	3.90	4.00
e	1.27 BSC		
H	5.80	6.00	6.20
L	0.50	0.715	0.93
α	0°	4°	8°
h	0.25	0.375	0.50



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